CERAMIC BALUN

RF Transformer

TCW2-6000+

50Ω 3100 to 6000 MHz 1:2 Ratio

FEATURES

- Wideband, 3100 to 6000 MHz
- Miniature size 0603 (1.6x0.8mm)
- LTCC construction
- Low cost
- Aqueous washable

Generic photo used for illustration purposes only

CASE STYLE: JC0603C

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- WLAN
- A/D conversion
- WiFi
- Transmitters and receivers
- Cellular

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (Secondary/Primary)			2		
Frequency Range		3100	—	6000	MHz
Avg. Insertion Loss[1]	3100 - 6000	—	1.1	1.8	dB
Amplitude Unbalance	3100 - 6000	—	1.5	2.5	dB
Phase Unbalance[2]	3100 - 6000	—	11	15	Degree

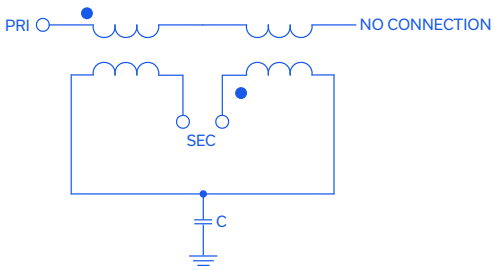
1. Reference Demo Board TB-912+
2. Relative to 180°

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Power	0.5W

Permanent damage may occur if any of these limits are exceeded.

CONFIGURATION R



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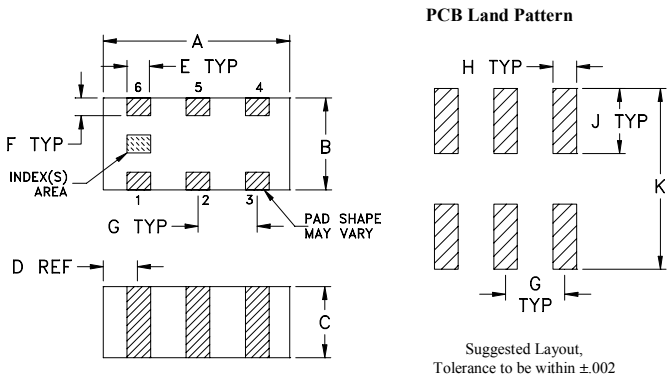
PAD CONNECTIONS

PRIMARY DOT (Unbalanced Port)	1
GND or DC FEED + RF	2
SECONDARY DOT (Balanced)	3
SECONDARY (Balanced)	4
NO CONNECTION	6
GND	5

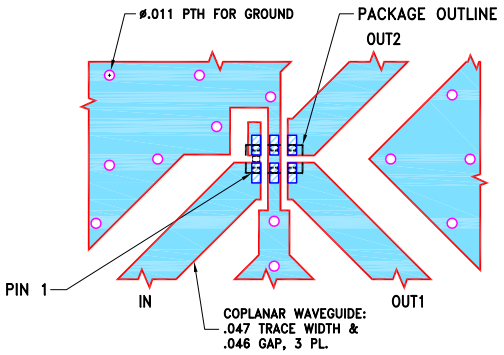
OUTLINE DRAWING



PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-912+

SUGGESTED PCB LAYOUT (PL-574)



NOTES:
1. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020±.0015. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F
.063	.031	.024	.012	.008	.006
1.60	0.79	0.61	0.30	0.20	0.15

G	H	J	K	wt
.020	.010	.022	.053	grams
0.51	0.25	0.56	1.35	0.005

TAPE & REEL INFORMATION: F114

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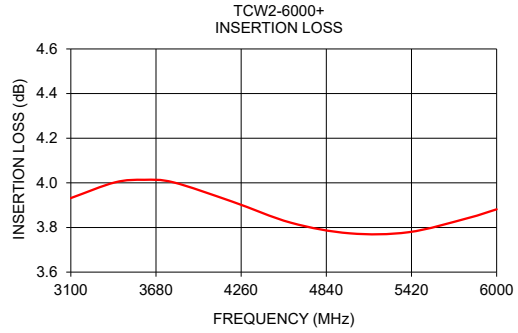
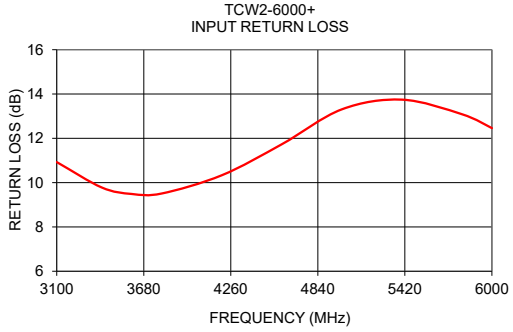
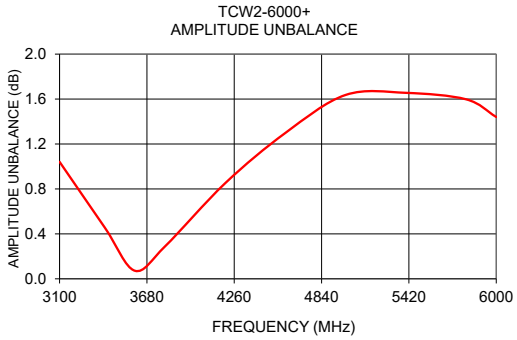
TYPICAL PERFORMANCE DATA[3]

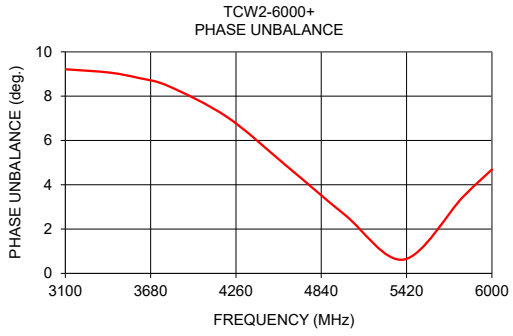
Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (deg)
3100.0	3.93	10.93	1.04	9.21
3400.0	4.00	9.78	0.46	9.06
3600.0	4.01	9.49	0.07	8.82
3800.0	4.00	9.51	0.29	8.46
4200.0	3.92	10.33	0.85	7.06
4600.0	3.82	11.73	1.30	4.87
5000.0	3.77	13.31	1.64	2.65
5400.0	3.78	13.75	1.66	0.62
5800.0	3.84	13.09	1.60	3.43
6000.0	3.88	12.46	1.44	4.69

3. Measured with Agilent E5071B network analyzer using impedance conversion and port extension.









NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

RF Transformer TCW2-6000+

Typical Performance Data

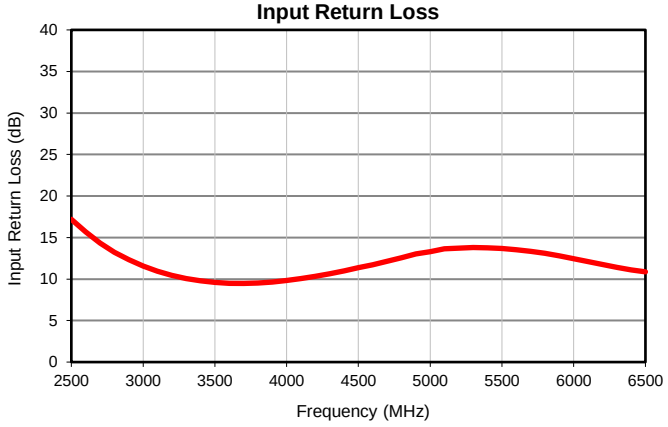
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
2500	0.80	17.19	2.22	8.19
2600	0.81	15.68	2.02	8.55
2700	0.82	14.35	1.82	8.86
2800	0.84	13.23	1.61	9.05
2900	0.87	12.31	1.43	9.16
3000	0.90	11.55	1.24	9.23
3100	0.93	10.93	1.04	9.21
3200	0.96	10.44	0.85	9.21
3300	0.99	10.07	0.65	9.05
3400	1.00	9.78	0.46	9.06
3500	1.01	9.60	0.27	8.91
3600	1.01	9.49	0.07	8.82
3700	1.01	9.47	0.11	8.61
3800	1.00	9.51	0.29	8.46
3900	0.98	9.63	0.45	8.12
4000	0.96	9.82	0.59	7.85
4100	0.94	10.06	0.74	7.48
4200	0.92	10.33	0.85	7.06
4300	0.89	10.64	0.98	6.59
4400	0.87	10.98	1.08	6.03
4500	0.84	11.35	1.20	5.46
4600	0.82	11.73	1.30	4.87
4700	0.80	12.15	1.41	4.36
4800	0.79	12.54	1.49	3.77
4900	0.77	13.01	1.58	3.20
5000	0.77	13.31	1.64	2.65
5100	0.78	13.64	1.67	2.21
5200	0.78	13.71	1.61	1.44
5300	0.77	13.78	1.63	0.22
5400	0.78	13.75	1.66	0.62
5500	0.79	13.68	1.67	1.50
5600	0.80	13.52	1.68	2.13
5700	0.82	13.32	1.64	2.76
5800	0.84	13.09	1.60	3.43
5900	0.86	12.81	1.52	4.07
6000	0.88	12.46	1.44	4.69
6100	0.91	12.10	1.33	5.26
6200	0.94	11.74	1.22	5.95
6300	0.96	11.40	1.09	6.50
6400	0.99	11.10	0.95	7.19
6500	1.02	10.87	0.78	7.63

RF Transformer TCW2-6000+

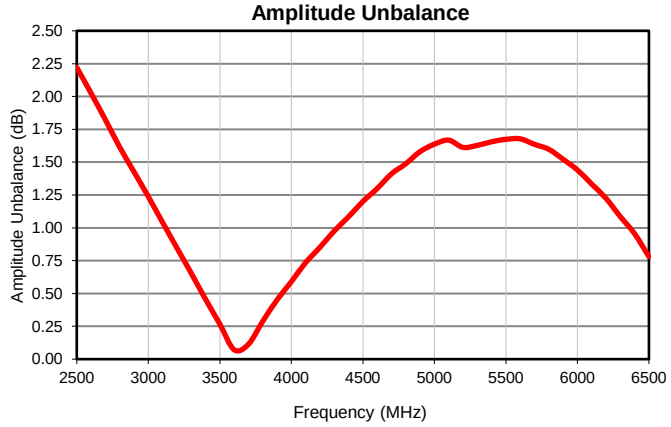
Typical Performance Data

Average Insertion Loss

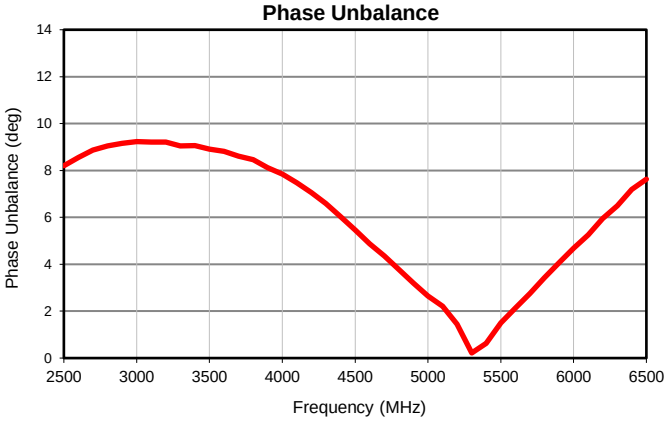
Input Return Loss



Amplitude Unbalance



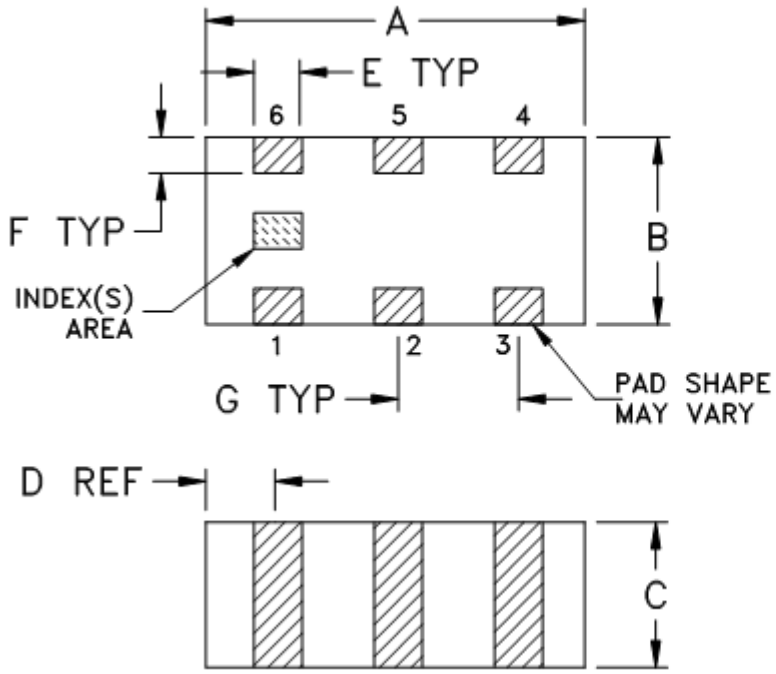
Phase Unbalance



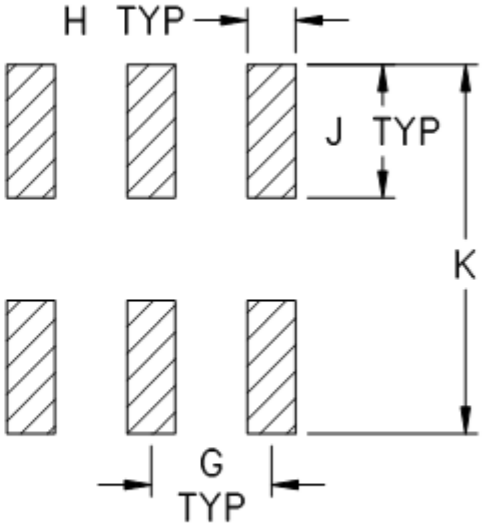
Case Style JC

Outline Dimensions

JC0603C



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
JC0603C	.063 (1.60)	.031 (0.80)	.024 (0.60)	.012 (0.30)	.008 (0.20)	.006 (0.15)	.020 (0.50)	.010 (0.25)	.022 (0.55)	0.053 (1.35)	.005

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish:
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

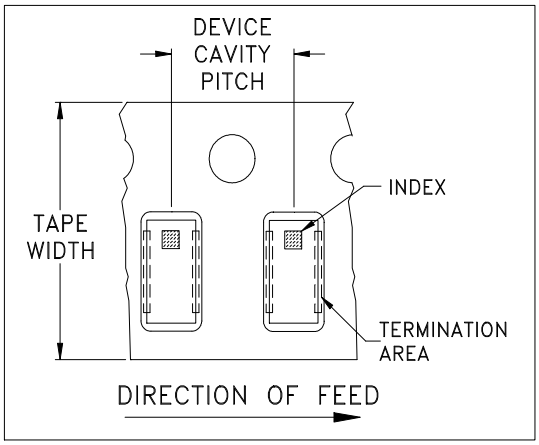


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

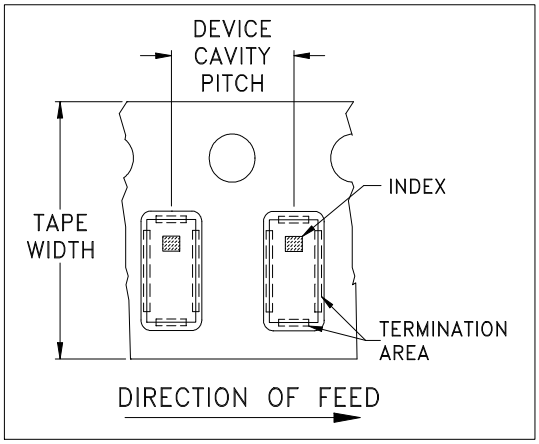


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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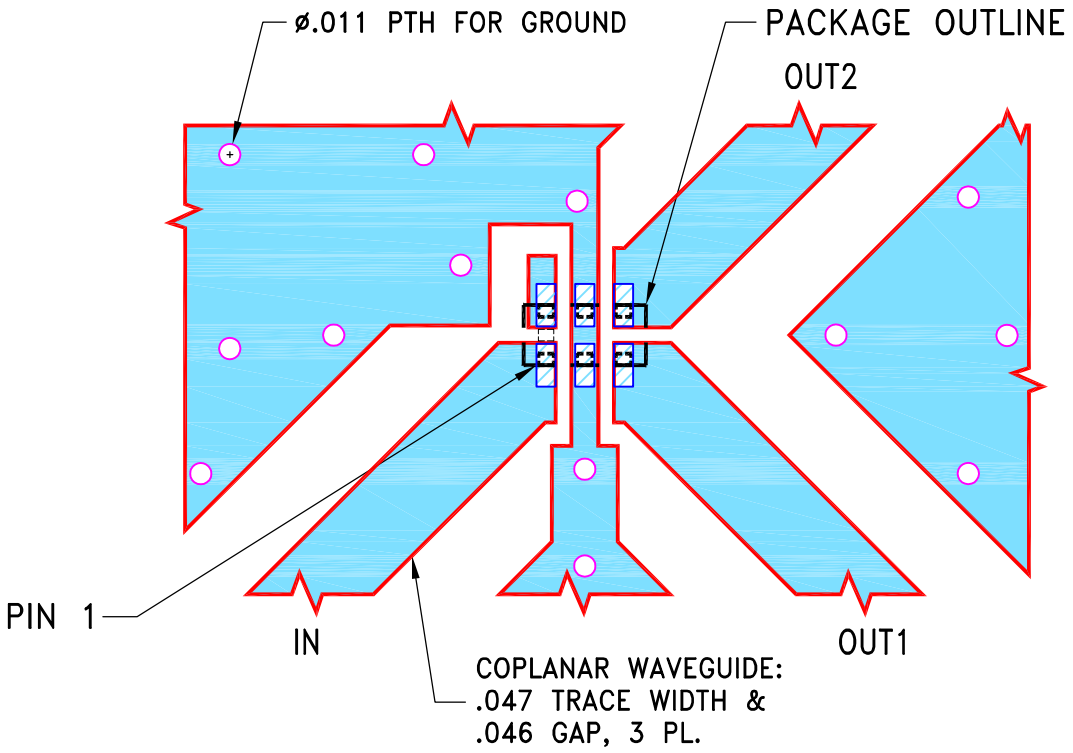
THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M166452	NEW RELEASE	02/22/18	ITG	BK

SUGGESTED MOUNTING CONFIGURATION
FOR JC0603C CASE STYLE, "06TR01" PIN CODE



NOTES:

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2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	02/20/18
TOLERANCES ON:	CHECKED	GF	02/21/18
2 PL DECIMALS ±	APPROVED	BK	02/22/18
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

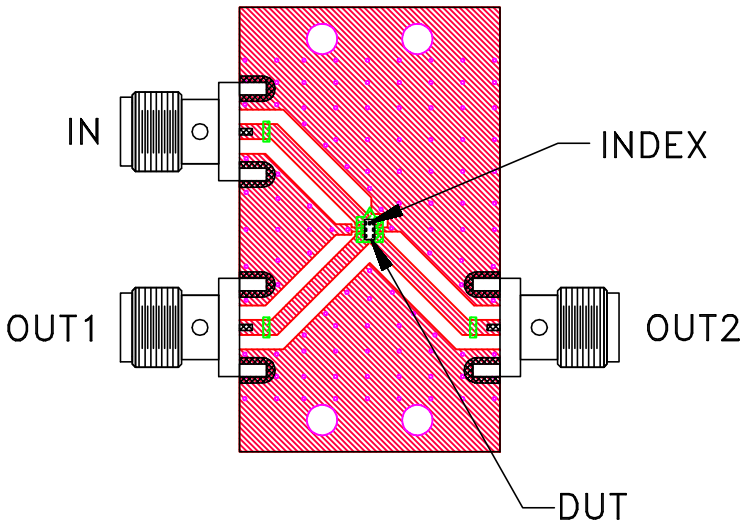
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, 06TR01, JC0603C, TB-912+

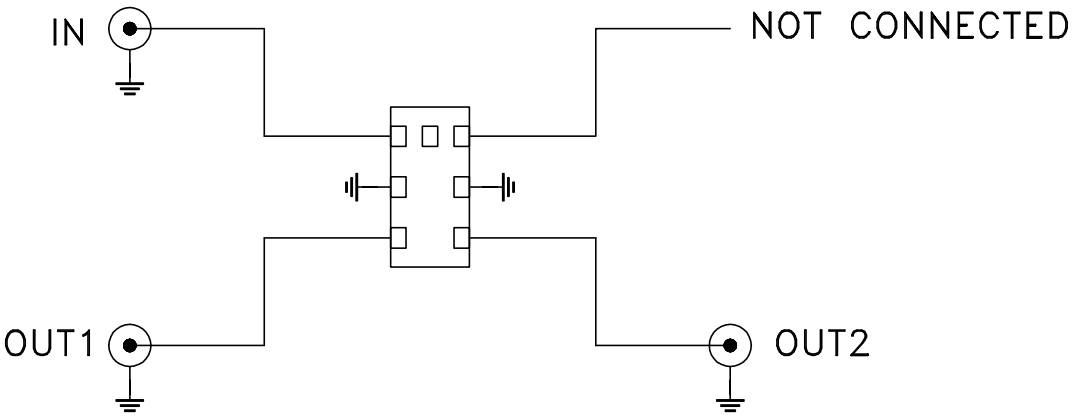
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-574	OR

FILE:	SCALE:	SHEET:
98PL574	10:1	1 OF 1

Evaluation Board and Circuit



TB-912+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: RO4350 or equivalent,
   Dielectric Constant=3.5,
   Thickness=.020 inch.

Mini-Circuits®

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Environmental Specifications ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A